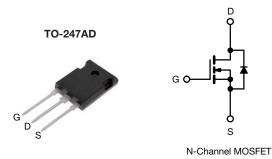
## SQW44N65EF

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Vishay Siliconix

# **E Series Power MOSFET With Fast Body Diode**



PRODUCT SUMMAR	RY		
V <sub>DS</sub> (V) at T <sub>J</sub> max.	700		
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.063	
Q <sub>g</sub> typ. (nC)	177		
Q <sub>gs</sub> (nC)	46		
Q <sub>gd</sub> (nC)	68		
Configuration	Single		

## **FEATURES**

- Fast body diode MOSFET using E series technology
- Reduced t<sub>rr</sub>, Q<sub>rr</sub>, and I<sub>RRM</sub>
- Low figure-of-merit (FOM): Ron x Qa
- Low input capacitance (Ciss)
- Low switching losses due to reduced Q<sub>rr</sub>
- 175 °C operating temperature
- AEC-Q101 qualified
- Ultra low gate charge (Q<sub>q</sub>)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

## **APPLICATIONS**

- Automotive onboard charger
- Automotive DC/DC converter

ORDERING INFORMATION	
Package	TO-247AD
Lead (Pb)-free and halogen-free	SQW44N65EF-GE3

ABSOLUTE MAXIMUM RATINGS (T	<sub>C</sub> = 25 °C, u	nless otherv	vise noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	650	v
Gate-source voltage		V <sub>GS</sub>	± 30	v	
Continuous dusin surrent (T 150 °C)	V at 10 V	T <sub>C</sub> = 25 °C		47	
Continuous drain current ( $T_J = 150 \ ^{\circ}C$ )	V <sub>GS</sub> at 10 V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$	I <sub>D</sub>	34	А
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	146	
Linear derating factor				3.3	W/°C
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	596	mJ
Maximum power dissipation			PD	500	W
Operating junction and storage temperature range	e		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C
Drain-source voltage slope	T <sub>J</sub> = 1	25 °C	dy /dt	100	1//20
Reverse diode dv/dt <sup>d</sup>	•		dv/dt	50	V/ns
Soldering recommendations (peak temperature) <sup>c</sup>	for	10 s		260	°C

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD}$  = 140 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>q</sub> = 25  $\Omega$ , I<sub>AS</sub> = 6.5 A

c. 1.6 mm from case

d.  $I_{SD} \leq I_D$ , di/dt = 145 A/µs, starting  $T_J$  = 25 °C

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R <sub>thJA</sub>	-	40	°C/W
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-	0.3	C/W

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PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		•					<b>I</b>
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 250 μA	650	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_J$	Reference	e to 25 °C, I <sub>D</sub> = 10 mA	-	0.7	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μΑ	2.0	-	4.0	V
			V <sub>GS</sub> = ± 20 V	-	-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>	,	V <sub>GS</sub> = ± 30 V	-	-	± 1	μA
Zeue ente un litere alusia summet		V <sub>DS</sub> =	= 520 V, V <sub>GS</sub> = 0 V	-	-	1	
Zero gate voltage drain current	IDSS	V <sub>DS</sub> = 520 V	∕, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	500	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 22 A	-	0.063	0.073	Ω
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub>	= 30 V, I <sub>D</sub> = 22 A	-	18	-	S
Dynamic		•			•	•	•
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 100 V,		-	5858	-	
Output capacitance	C <sub>oss</sub>			-	227	-	
Reverse transfer capacitance	C <sub>rss</sub>		f = 1 MHz	-	6	-	рF
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 0 V to 520 V		-	173	-	
Effective output capacitance, time related b	C <sub>o(tr)</sub>				710	-	
Total gate charge	Qg			-	177	266	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 22 A, V <sub>DS</sub> = 520 V	-	46	-	nC
Gate-drain charge	Q <sub>gd</sub>			-	68	-	
Turn-on delay time	t <sub>d(on)</sub>			-	47	94	
Rise time	t <sub>r</sub>	V <sub>DD</sub> =	= 520 V, I <sub>D</sub> = 22 A	-	71	142	
Turn-off delay time	t <sub>d(off)</sub>	$R_{g} = 9.1 \Omega, V_{GS} = 10 V$		-	206	412	- ns
Fall time	t <sub>f</sub>			-	66	132	
Gate input resistance	Rg	f = 1 MHz, open drain		0.5	1.0	2.0	Ω
Drain-Source Body Diode Characteristics	i						
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol		-	-	47	
Pulsed diode forward current	I <sub>SM</sub>	integral revers p - n junction		-	-	146	A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	C, I <sub>S</sub> = 22 A, V <sub>GS</sub> = 0 V	-	0.9	1.2	V
Reverse recovery time	t <sub>rr</sub>			-	190	380	ns
Reverse recovery charge	Q <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = I_S = 22 \text{ A},$ di/dt = 100 A/µs, V <sub>B</sub> = 400 V		-	1.7	3.4	μC
Reverse recovery current	I <sub>RRM</sub>		$100 \text{ Av} \mu \text{s}, \text{ v}_{\text{R}} = 400 \text{ v}$	-	17	-	Α

Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ 

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ 

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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

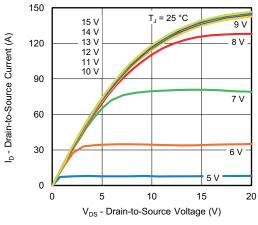


Fig. 1 - Typical Output Characteristics

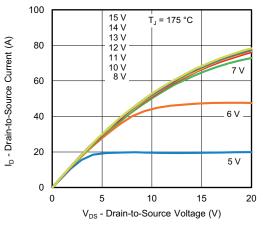


Fig. 2 - Typical Output Characteristics

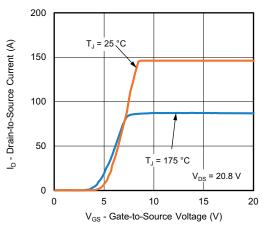


Fig. 3 - Typical Transfer Characteristics

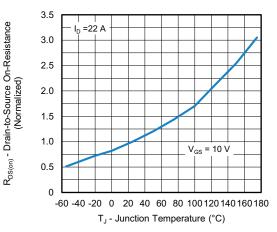


Fig. 4 - Normalized On-Resistance vs. Temperature

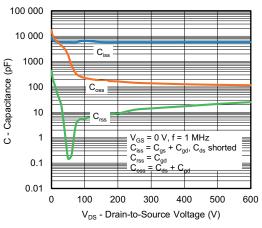
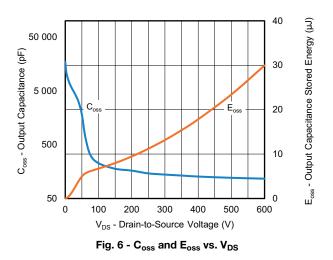


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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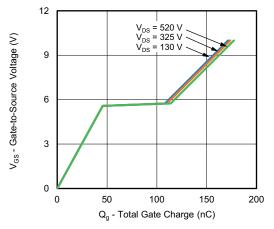


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

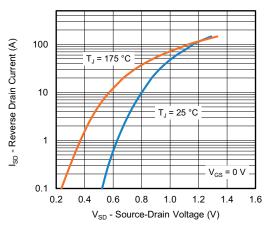


Fig. 8 - Typical Source-Drain Diode Forward Voltage

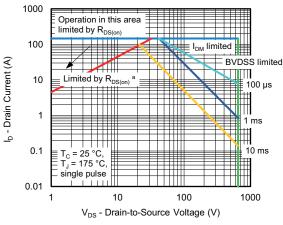


Fig. 9 - Maximum Safe Operating Area

Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

4

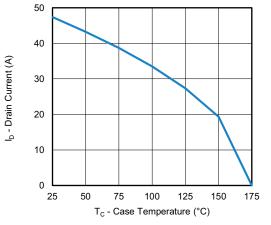


Fig. 10 - Maximum Drain Current vs. Case Temperature

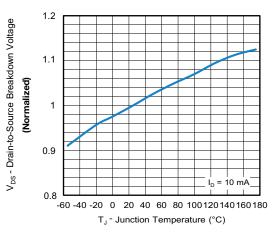
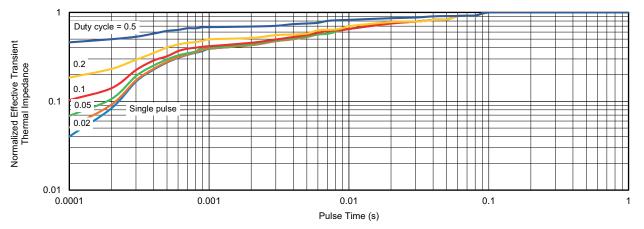


Fig. 11 - Typical Drain-to-Source Voltage vs. Temperature



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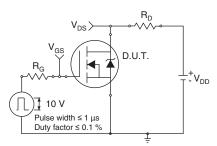


Fig. 13 - Switching Time Test Circuit

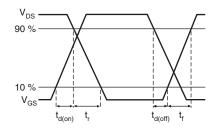


Fig. 14 - Switching Time Waveforms

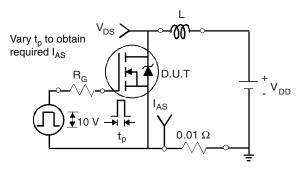


Fig. 15 - Unclamped Inductive Test Circuit

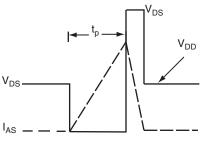


Fig. 16 - Unclamped Inductive Waveforms

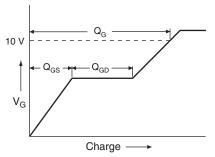


Fig. 17 - Basic Gate Charge Waveform

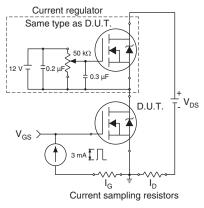


Fig. 18 - Gate Charge Test Circuit

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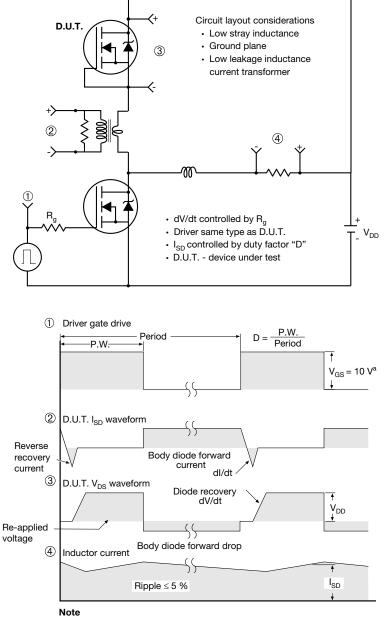
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### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS} = 5$  V for logic level devices

Fig. 19 - For N-Channel

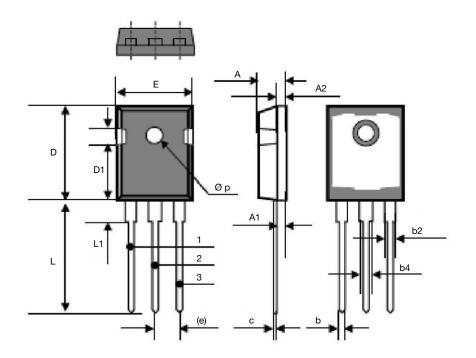
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# TO-247AD (High Voltage)



DIM.	MILLIN	<b>METERS</b>	INCHES		
	MIN.	MAX.	MIN.	MAX.	
А	4.70	5.31	0.185	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.50	2.49	0.059	0.098	
b	0.99	1.40	0.039	0.055	
b2	1.65	2.41	0.065	0.095	
b4	2.59	3.43	0.102	0.135	
С	0.61	BSC	0.024 BSC		
D	20.80	21.46	0.819	0.845	
D1	3.68	5.49	0.145	0.216	
(e)	5.46 BSC		0.215 BSC		
E	15.49	16.26	0.610	0.640	
L	19.81	20.32	0.780	0.800	
L1	4.06	4.50	0.160	0.177	
Øp	3.51	3.66	0.138	0.144	

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